

STD878T4 HIGH CURRENT, HIGH PERFORMANCE, LOW VOLTAGE NPN TRANSISTOR

Features

- VERY LOW COLLECTOR TO EMITTER SATUARATION VOLTAGE
- DC CURRENT GAIN, h_{FE} > 100
- 5 A CONTINUOUS COLLECTOR CURRENT
- SURFACE-MOUNTING DPAK (TO-252)
- POWER PACKAGE IN TAPE & REEL

Applications

- POWER MANAGEMENT IN PORTABLE EQUIPMENT
- VOLTAGE REGULATION IN BIAS SUPPLY CIRCUITS
- SWITCHING REGULATOR IN BATTERY CHARGER APPLICATIONS
- HEAVY LOAD DRIVER

Description

The device is manufactured in low voltage NPN Planar technology by using a "Base Island" layout. The resulting transistor shows exceptional high gain performance coupled with very low saturation voltage.



Internal Schematic Diagram



Order Codes

Part Number	Marking	Package	Packing	
STD878T4	D878	DPAK (TO-252)	Tape & Reel	

Preliminary Data

1 Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage (I _E = 0)	45	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	30	V
V _{EBO}	Emitter-Base Voltage $(I_C = 0)$	6	V
۱ _C	Collector Current	5	А
I _{CM}	Collector Peak Current (t _P < 5ms)	10	А
P _{TOT}	Total dissipation at $T_c = 25^{\circ}C$	15	W
T _{stg}	Storage Temperature	-65 to 150	°C
TJ	Max. Operating Junction Temperature	150	°C

Table 1. Absolute Maximum Rating

Table 2.Thermal Data

Symbol	Parameter	Value	Unit	
R _{thJ-case}	Thermal Resistance Junction-Case Max		8.33	°C/W



2 Electrical Characteristics

Symbol	Parameter	Test C	onditions	Min.	Тур.	Max.	Unit
I _{CBO}	Collector Cut-off Current (I _E = 0)	V _{CB} = 30 V V _{CB} = 30 V	T _j = 100 ^o C			10 100	μΑ μΑ
I _{EBO}	Emitter Cut-off Current $(I_{C} = 0)$	V _{EB} = 6 V				10	μA
V _{(BR)CEO} Note: 1	Collector-Emitter Breakdown Voltage (I _B = 0)	l _C = 10 mA		30			V
V _{(BR)CBO}	Collector-Base Breakdown Voltage (I _E = 0)	I _C = 100 μA		45			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage $(I_C = 0)$	I _E = 100 μA		6			V
V _{CE(sat)} Note: 1	Collector-Emitter Saturation Voltage	$I_{C} = 500 \text{ mA}$ $I_{C} = 2 \text{ A}$ $I_{C} = 5 \text{ A}$ $I_{C} = 6 \text{ A}$ $I_{C} = 8 \text{ A}$ $I_{C} = 10 \text{ A}$	$I_{B} = 5 mA$ $I_{B} = 50 mA$ $I_{B} = 250 mA$ $I_{B} = 250 mA$ $I_{B} = 400 mA$ $I_{B} = 500 mA$		0.7 1.0 1.2	0.15 0.35 0.70	V V V V V
V _{BE(sat)} Note: 1	Base-Emitter Saturation Voltage	$I_{\rm C} = 2 \text{ A}$ $I_{\rm C} = 6 \text{ A}$	I _B = 50 mA I _B = 250 mA		1.2	1.1	V V
h _{FE} Note: 1	DC Current Gain	$I_{C} = 10 \text{ mA}$ $I_{C} = 500 \text{ mA}$ $I_{C} = 5 \text{ A}$ $I_{C} = 5 \text{ A}$ $T_{j} = 100 \text{ °C}$ $I_{C} = 8 \text{ A}$ $I_{C} = 10 \text{ A}$	$V_{CE} = 1 V$	120 100 70	200 200 100 100 55 35	300	
t _d t _r t _s t _f	RESISTIVE LOAD Delay Time Rise Time Storage Time Fall Time	$V_{CC} = 20 V$ $I_{B1} = -I_{B2} = 60$ (see figure 1)	I _C = 3 A 9 mA		180 160 250 80	220 210 300 100	ns ns ns ns

Table 3.	Electrical Characteristics	$(T_{CASE} = 25^{\circ}C)$	unless oth	nerwise s	pecified)
10010 01		(CASE - 0 0,	00000	10111100 0	poomoa,

Note: 1 Pulsed duration = $300 \ \mu s$, duty cycle $\le 1.5\%$.



3 Test Circuits



Figure 1. Resistive Load Switching Test Circuit



4 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



DIM.		mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А	2.20		2.40	0.087		0.094		
A1	0.90		1.10	0.035		0.043		
A2	0.03		0.23	0.001		0.009		
В	0.64		0.90	0.025		0.035		
B2	5.20		5.40	0.204		0.213		
С	0.45		0.60	0.018		0.024		
C2	0.48		0.60	0.019		0.024		
D	6.00		6.20	0.236		0.244		
Е	6.40		6.60	0.252		0.260		
G	4.40		4.60	0.173		0.181		
Н	9.35		10.10	0.368		0.398		
L2		0.8			0.031			
L4	0.60		1.00	0.024		0.039		
V2	0°		8°	0°		0 [°]		

TO-252 (DPAK) MECHANICAL DATA



5 Revision History

Date	Revision	Changes
24-Nov-2005	1	Initial Release



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